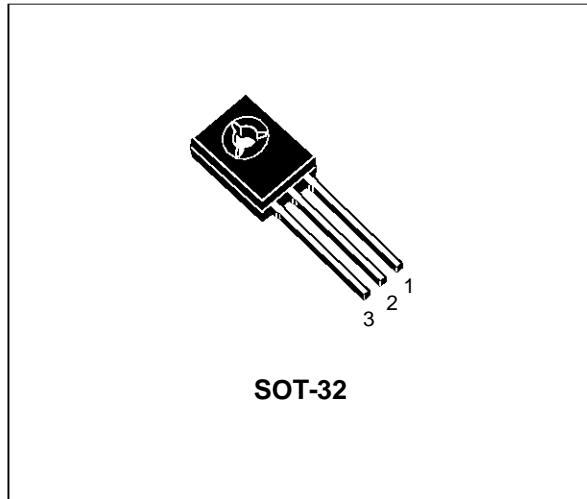


SILICON PNP TRANSISTOR

- SGS-THOMSON PREFERRED SALESTYPE
- PNP TRANSISTOR

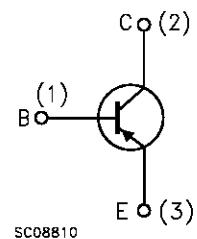
DESCRIPTION

The MJE210 is a silicon epitaxial-base PNP transistor in Jedec SOT-32 plastic package, designed for low voltage, low power, high gain audio amplifier applications.



SOT-32

INTERNAL SCHEMATIC DIAGRAM



ABSOLUTE MAXIMUM RATINGS

Symbol	Parameter	Value	Unit
V_{CBO}	Collector-Base Voltage ($I_E = 0$)	-40	V
V_{CEO}	Collector-Emitter Voltage ($I_B = 0$)	-25	V
V_{EBO}	Base-Emitter Voltage ($I_C = 0$)	-8	V
I_C	Collector Current	-5	A
I_{CM}	Collector Peak Current	-10	A
I_B	Base Current	-1	A
P_{tot}	Total Power Dissipation at $T_{case} \leq 25^\circ\text{C}$ at $T_{amb} \leq 25^\circ\text{C}$	15 1.5	W
T_{stg}	Storage Temperature	-65 to 150	$^\circ\text{C}$
T_j	Max Operating Junction Temperature	150	$^\circ\text{C}$

THERMAL DATA

R _{thj-amb}	Thermal Resistance Junction-ambient	Max	83.4	°C/W
R _{thj-case}	Thermal Resistance Junction-case	Max	8.34	°C/W

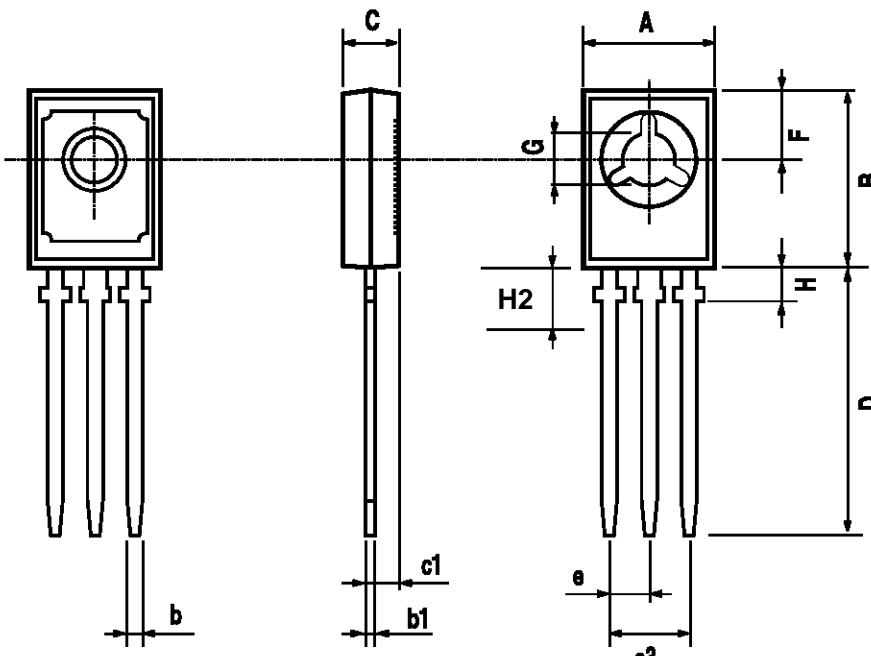
ELECTRICAL CHARACTERISTICS ($T_{case} = 25$ °C unless otherwise specified)

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
I _{cBO}	Collector Cut-off Current ($I_E = 0$)	V _{CB} = -40 V V _{CB} = -40 V T _{CASE} = 125°C			-100 -100	nA μA
I _{EBO}	Emitter Cut-off Current ($I_C = 0$)	V _{EB} = -8 V			-100	nA
V _{CEO(sus)*}	Collector-Emitter Sustaining Voltage	I _C = -10 mA	-25			V
V _{CE(sat)*}	Collector-Emitter Sustaining Voltage	I _C = -0.5 A I _C = -2 A I _C = -5 A	I _B = -50 mA I _B = -0.2 A I _B = -1 A		-0.3 -0.75 -1.8	V V V
V _{BE(sat)*}	Base-Emitter on Voltage	I _C = -5 A	I _B = -1 A		-2.5	V
V _{BE*}	Base-Emitter on Voltage	I _C = -2 A	V _{CE} = -1 V		-1.6	V
h _{FE*}	DC Current Gain	I _C = -0.5 A I _C = -2 A I _C = -5 A	V _{CE} = -1 V V _{CE} = -1 V V _{CE} = -2 V	70 45 10	180	
f _T	Transistor Frequency	I _C = 0.1 A f = 10 MHz	V _{CE} = 10 V	65		MHz
C _{cBO}	Collector-base Capacitance	V _{CB} = -10 V I _E = 0	f = 0.1 MHz		120	pF

* Pulsed: Pulse duration = 300μs, duty cycle ≤ 1.5%

SOT-32 (TO-126) MECHANICAL DATA						
DIM.	mm			inch		
	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.
A	7.4		7.8	0.291		0.307
B	10.5		10.8	0.413		0.445
b	0.7		0.9	0.028		0.035
b1	0.49		0.75	0.019		0.030
C	2.4		2.7	0.040		0.106
c1	1.0		1.3	0.039		0.050
D	15.4		16.0	0.606		0.629
e		2.2			0.087	
e3	4.15		4.65	0.163		0.183
F		3.8			0.150	
G	3		3.2	0.118		0.126
H			2.54			0.100
H2		2.15			0.084	

DIM.	mm			inch		
DIM.	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.
A	7.4		7.8	0.291		0.307
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